

5N50K-MT Power MOSFET

# 5A, 500V N-CHANNEL POWER MOSFET

#### **■** DESCRIPTION

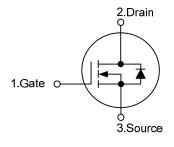
The UTC **5N50K-MT** is an N-channel power MOSFET adopting UTC's advanced technology to provide customers with DMOS, planar stripe technology. This technology is designed to meet the requirements of the minimum on-state resistance and perfect switching performance. It also can withstand high energy pulse in the avalanche and communication mode.

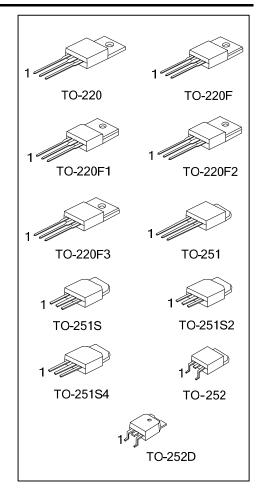
The UTC **5N50K-MT** can be used in applications, such as active power factor correction, high efficiency switched mode power supplies, electronic lamp ballasts based on half bridge topology.

#### ■ FFATURES

- \*  $R_{DS(ON)}$  < 1.4 $\Omega$  @  $V_{GS}$ =10V,  $I_{D}$ =2.5A
- \* 100% avalanche tested
- \* High switching speed

#### ■ SYMBOL

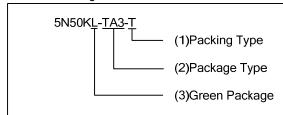




#### ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
5N50KL-TA3-T	5N50KG-TA3-T	TO-220	G	D	S	Tube	
5N50KL-TF3-T	5N50KG-TF3-T	TO-220F	G	D	S	Tube	
5N50KL-TF1-T	5N50KG-TF1-T	TO-220F1	G	D	S	Tube	
5N50KL-TF2-T	5N50KG-TF2-T	TO-220F2	G	D	S	Tube	
5N50KL-TF3-T	5N50KG-TF3-T	TO-220F3	G	D	S	Tube	
5N50KL-TM3-T	5N50KG-TM3-T	TO-251	G	D	S	Tube	
5N50KL-TMS-T	5N50KG-TMS-T	TO-251S	G	D	S	Tube	
5N50KL-TMS2-T	5N50KG-TMS2-T	TO-251S2	G	D	S	Tube	
5N50KL-TMS4-T	5N50KG-TMS4-T	TO-251S4	G	D	S	Tube	
5N50KL-TN3-R	5N50KG-TN3-R	TO-252	G	D	S	Tape Reel	
5N50KL-TND-R	5N50KG-TND-R	TO-252D	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source

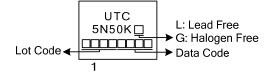


- (1) T: Tube, R: Tape Reel
- (2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TF3: TO-220F3, TM3: TO-251 TMS: TO-251S, TMS2: TO-251S2,

TMS4: TO-251S4, TN3: TO-252, TND: TO-252D

(3) L: Lead Free, G: Halogen Free and Lead Free

## **MARKING**





## ■ ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	500	V
Gate-Source Voltage		$V_{GSS}$	±30	V
Drain Current	Continuous	$I_{D}$	5	Α
	Pulsed (Note 2)	$I_{DM}$	20	Α
Avalanche Current (Note 2)		$I_{AR}$	5	Α
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	150	mJ
	Repetitive (Note 2)	$E_{AR}$	7.3	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
	TO-220	P <sub>D</sub>	78	W
Power Dissipation	TO-220F/TO-220F1 TO-220F3		36	W
	TO-220F2		29	W
	TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D		54	W
Junction Temperature		$T_J$	+150	°C
Storage Temperature		T <sub>STG</sub>	-55~+150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 12mH,  $I_{AS}$  = 5A,  $V_{DD}$  = 50V,  $R_G$  = 25 $\Omega$ , Starting  $T_J$  = 25 $^{\circ}$ C
- 4.  $I_{SD} \le 5A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$

#### **■ THERMAL DATA**

PARAMETER		SYMBOL	RATINGS	UNIT	
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2 TO-220F3	0	62.5	°C/W	
	TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D	$ heta_{ m JA}$	110	°C/W	
Junction to Case	TO-220		1.16	°C/W	
	TO-220F/TO-220F1 TO-220F3		4.2	°C/W	
	TO-220F2	$\theta_{\sf JC}$	4.18	°C/W	
	TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D		2.3	°C/W	



# **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		$BV_{DSS}$	$I_D=250\mu A, V_{GS}=0V$	500			V	
Breakdown Voltage Temperature	e Coefficient	$\triangle BV_{DSS} \! / \triangle T_J$	Reference to 25°C, I <sub>D</sub> =250µA		0.5		V/°C	
Danier Courses Lankson Coursest			V <sub>DS</sub> =500V, V <sub>GS</sub> =0V			1		
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =400V, T <sub>C</sub> =125°C			10	μΑ	
Gate- Source Leakage Current	Forward	-	V <sub>GS</sub> =30V, V <sub>DS</sub> =0V			100	nΑ	
	Reverse	$I_{GSS}$	$V_{GS}$ =-30V, $V_{DS}$ =0V			-100	nΑ	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_D=250\mu A$	2.0		4.0	٧	
Static Drain-Source On-State Re	esistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =2.5A		1.23	1.4	Ω	
DYNAMIC PARAMETERS								
Input Capacitance	out Capacitance		\\ -0\\ \\ -25\\		525	625	pF	
Output Capacitance	Output Capacitance		V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0MHz		64	105	pF	
Reverse Transfer Capacitance		C <sub>OSS</sub> C <sub>RSS</sub>	I – I.OVIAZ		6	20	pF	
SWITCHING PARAMETERS								
Turn-ON Delay Time		t <sub>D(ON)</sub>			46	60	ns	
Rise Time		$t_R$	$V_{DD}$ =30V, $I_{D}$ =0.5A,		50	70	ns	
Turn-OFF Delay Time		$t_{D(OFF)}$	R <sub>G</sub> =25Ω (Note 1, 2)		54	130	ns	
Fall-Time		$t_{F}$			44	105	ns	
Total Gate Charge		$Q_G$	V <sub>GS</sub> =10V, V <sub>DS</sub> =50V,		21.6	24	nC	
Gate to Source Charge		$Q_GS$	I <sub>D</sub> =1.3A (Note 1, 2)		5.6		nC	
Gate to Drain Charge	Gate to Drain Charge		ID-1.3A (Note 1, 2)		5.5		nC	
SOURCE- DRAIN DIODE RATI	NGS AND CI	HARACTERIS'	TICS					
Maximum Continuous Drain-Source Diode		Is				5	Α	
Forward Current						3	А	
Maximum Pulsed Drain-Source Diode		I <sub>SM</sub>				20	Α	
Forward Current						20	^	
Drain-Source Diode Forward Voltage		$V_{SD}$	I <sub>S</sub> =5A, V <sub>GS</sub> =0V			1.4	V	
Reverse Recovery Time		t <sub>rr</sub>	7 9 7		263		ns	
Reverse Recovery Charge		$Q_{RR}$	dI <sub>F</sub> /dt=100A/μs (Note 1)		1.9		μC	

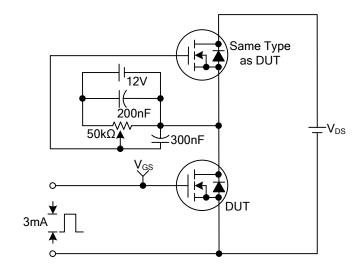
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

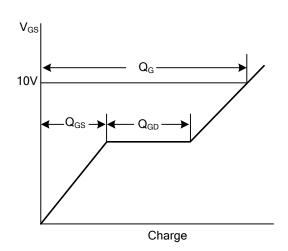
2. Essentially independent of operating temperature.



5N50K-MT **Power MOSFET** 

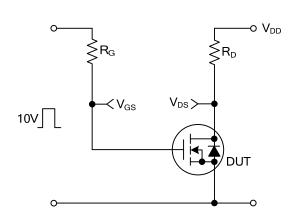
## **TEST CIRCUITS AND WAVEFORMS**

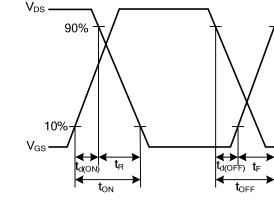




**Gate Charge Test Circuit** 

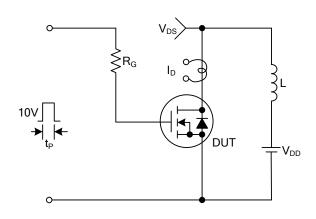
**Gate Charge Waveforms** 

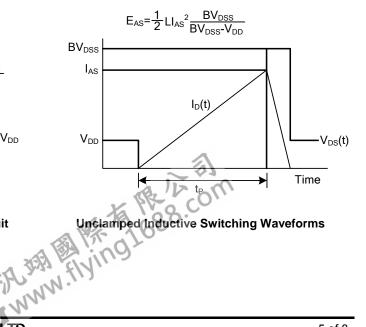




**Resistive Switching Test Circuit** 

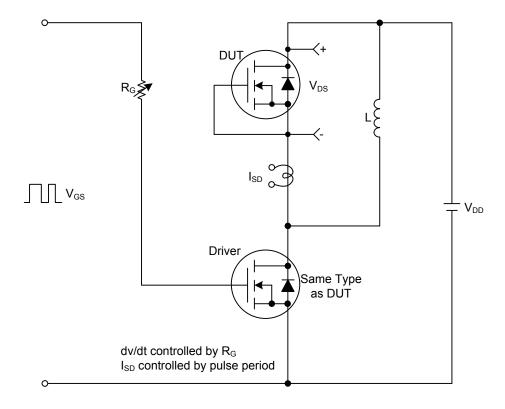
**Resistive Switching Waveforms** 



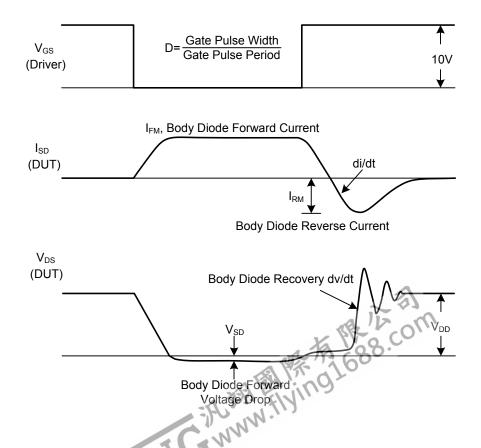


**Unclamped Inductive Switching Test Circuit** 

## ■ TEST CIRCUITS AND WAVEFORMS(Cont.)

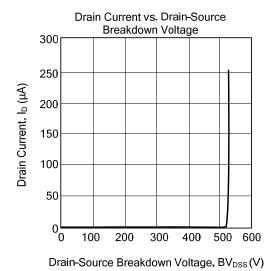


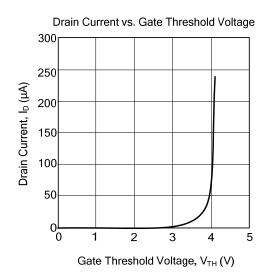
Peak Diode Recovery dv/dt Test Circuit & Waveforms

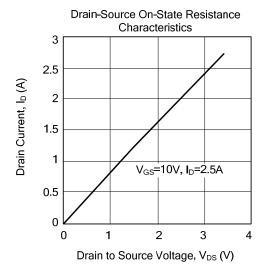


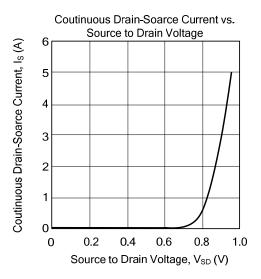
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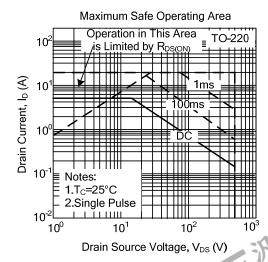
#### **■ TYPICAL CHARACTERISTICS**











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